

### General Description

The 8680A is N-channel MOS Field Effect Transistor designed for high current switching applications. Rugged E<sub>AS</sub> capability and ultra low R<sub>DS(ON)</sub> is suitable for PWM, load switching especially for E-Bike controller applications.

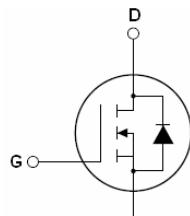
### Features

| VDSS | RDS(ON)<br>@10V (typ) | ID  |
|------|-----------------------|-----|
| 80V  | 6.6 mΩ                | 92A |

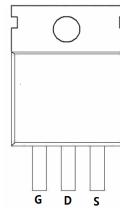
- Special Designed for E-Bike Controller Application
- Ultra Low On-Resistance
- High UIS and UIS 100% Test

### Application

- 64V E-Bike Controller Applications
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply



Schematic Diagram



Marking and pin assignment



To-220 Top View

### Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|--------|----------------|-----------|------------|----------|
| 8680A          | 8680A  | TO-220         | -         | -          | -        |

Table 1. Absolute Maximum Ratings (TA=25°C)

| Symbol                            | Parameter  | Value      | Unit |
|-----------------------------------|--|------------|------|
| V <sub>DS</sub>                   | Drain-Source Voltage (V <sub>GS</sub> =0V)                   | 80         | V    |
| V <sub>GS</sub>                   | Gate-Source Voltage (V <sub>DS</sub> =0V)                    | ±25        | V    |
| I <sub>D</sub> (DC)               | Drain Current (DC) at T <sub>c</sub> =25°C                   | 92         | A    |
| I <sub>D</sub> (DC)               | Drain Current (DC) at T <sub>c</sub> =100°C                  | 64.4       | A    |
| I <sub>DM</sub> (pulse)           | Drain Current-Continuous@ Current-Pulsed <sup>(Note 1)</sup> | 368        | A    |
| dv/dt                             | Peak Diode Recovery Voltage                                  | 30         | V/ns |
| P <sub>D</sub>                    | Maximum Power Dissipation(T <sub>c</sub> =25°C)              | 139        | W    |
|                                   | Derating Factor  | 0.93       | W/°C |
| E <sub>AS</sub>                   | Single Pulse Avalanche Energy <sup>(Note 2)</sup>            | 625        | mJ   |
| T <sub>J</sub> , T <sub>STG</sub> | Operating Junction and Storage Temperature Range             | -55 To 175 | °C   |

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.E<sub>AS</sub> condition:T<sub>J</sub>=25°C,V<sub>DD</sub>=40V,V<sub>G</sub>=10V,R<sub>G</sub>=25 Ω

**Table 2. Thermal Characteristic**

| Symbol          | Parameter                            | Value | Unit |
|-----------------|--------------------------------------|-------|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | 1.08  | °C/W |

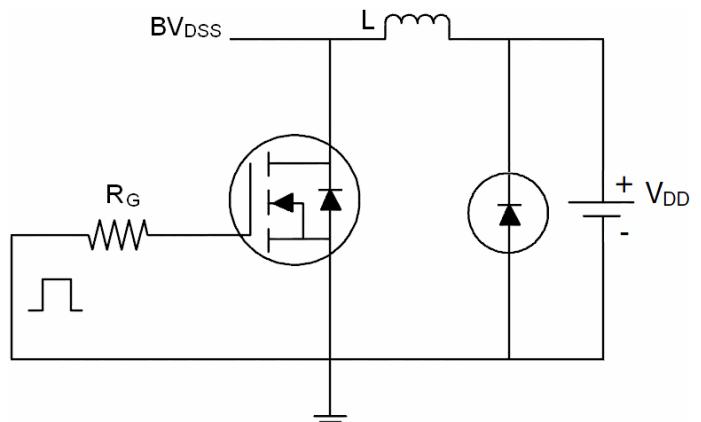
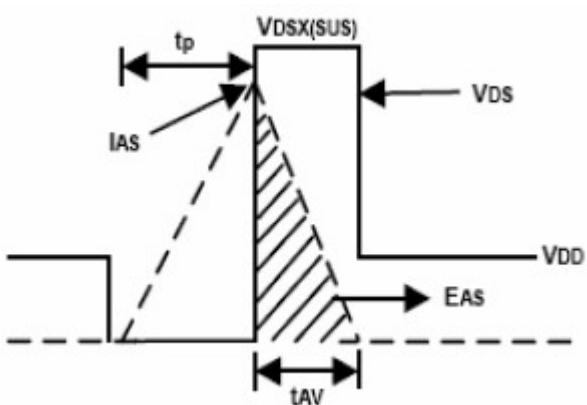
**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

| Symbol                                    | Parameter                                   | Conditions   | Min | Typ  | Max  | Unit |
|---|---|--|-----|------|------|------|
| <b>On/Off States</b>                      |   |  |     |      |      |      |
| $BV_{DSS}$                                | Drain-Source Breakdown Voltage              | $V_{GS}=0V, I_D=250\mu A$  | 82  |      |      | V    |
| $I_{DS(on)}$                              | Zero Gate Voltage Drain Current(Tc=25°C)    | $V_{DS}=82V, V_{GS}=0V$  |     | 1    |      | μA   |
| $I_{DS(on)}$                              | Zero Gate Voltage Drain Current(Tc=125°C)   | $V_{DS}=82V, V_{GS}=0V$  |     | 10   |      | μA   |
| $I_{GSS}$                                 | Gate-Body Leakage Current                   | $V_{GS}=\pm 20V, V_{DS}=0V$  |     |      | ±100 | nA   |
| $V_{GS(th)}$                              | Gate Threshold Voltage                      | $V_{DS}=V_{GS}, I_D=250\mu A$  | 2   | 2.8  | 4    | V    |
| $R_{DS(on)}$                              | Drain-Source On-State Resistance            | $V_{GS}=10V, I_D=40A$  |     | 6.6  | 7.8  | mΩ   |
| <b>Dynamic Characteristics</b>            |   |  |     |      |      |      |
| $g_{FS}$                                  | Forward Transconductance                    | $V_{DS}=10V, I_D=15A$  | 20  |      |      | S    |
| $C_{iss}$                                 | Input Capacitance                           | $V_{DS}=25V, V_{GS}=0V, f=1.0MHz$  |     | 5053 |      | PF   |
| $C_{oss}$                                 | Output Capacitance                          |  |     | 442  |      | PF   |
| $C_{rss}$                                 | Reverse Transfer Capacitance                |  |     | 145  |      | PF   |
| $Q_g$                                     | Total Gate Charge                           | $V_{DS}=50V, I_D=40A, V_{GS}=10V$  |     | 106  |      | nC   |
| $Q_{gs}$                                  | Gate-Source Charge                          |  |     | 19   |      | nC   |
| $Q_{gd}$                                  | Gate-Drain Charge                           |  |     | 47.9 |      | nC   |
| <b>Switching Times</b>                    |   |  |     |      |      |      |
| $t_{d(on)}$                               | Turn-on Delay Time                          | $V_{DD}=30V, I_D=40A, R_L=15\Omega, V_{GS}=10V, R_G=2.5\Omega$           |     | 15   |      | nS   |
| $t_r$                                     | Turn-on Rise Time                           |  |     | 18   |      | nS   |
| $t_{d(off)}$                              | Turn-Off Delay Time                         |  |     | 31   |      | nS   |
| $t_f$                                     | Turn-Off Fall Time                          |  |     | 38   |      | nS   |
| <b>Source-Drain Diode Characteristics</b> |   |  |     |      |      |      |
| $I_{SD}$                                  | Source-drain Current(Body Diode)            |  |     | 92   |      | A    |
| $I_{SDM}$                                 | Pulsed Source-Drain Current(Body Diode)     |  |     | 368  |      | A    |
| $V_{SD}$                                  | Forward On Voltage <sup>(Note 1)</sup>      | $T_J=25^{\circ}C, I_{SD}=40A, V_{GS}=0V$                                 |     | 0.78 | 0.95 | V    |
| $t_{rr}$                                  | Reverse Recovery Time <sup>(Note 1)</sup>   | $T_J=25^{\circ}C, I_F=75A, di/dt=100A/\mu s$                             |     | 56   |      | nS   |
| $Q_{rr}$                                  | Reverse Recovery Charge <sup>(Note 1)</sup> |  |     | 113  |      | nC   |
| $t_{on}$                                  | Forward Turn-on Time                        | Intrinsic turn-on time is negligible(turn-on is dominated by $L_S+L_D$ ) |     |      |      |      |

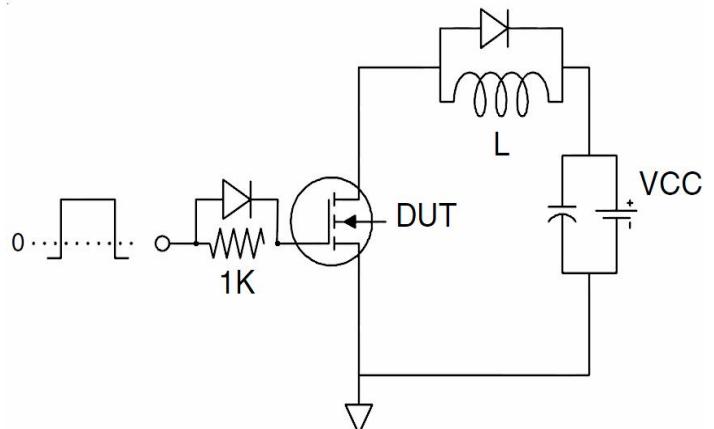
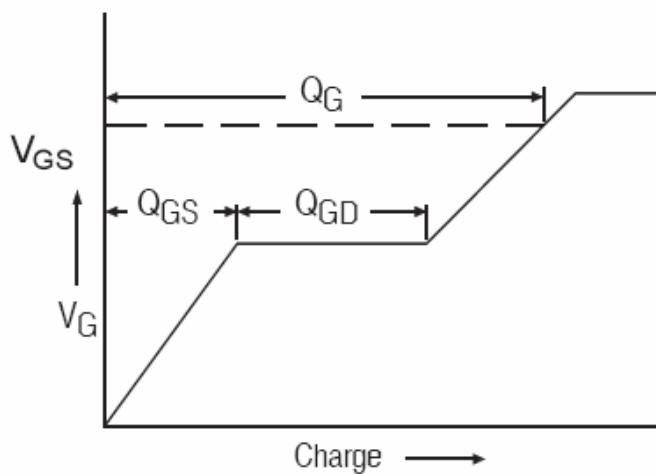
Notes 1.Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 1.5%, RG=25Ω, Starting T<sub>J</sub>=25°C

## Test Circuit

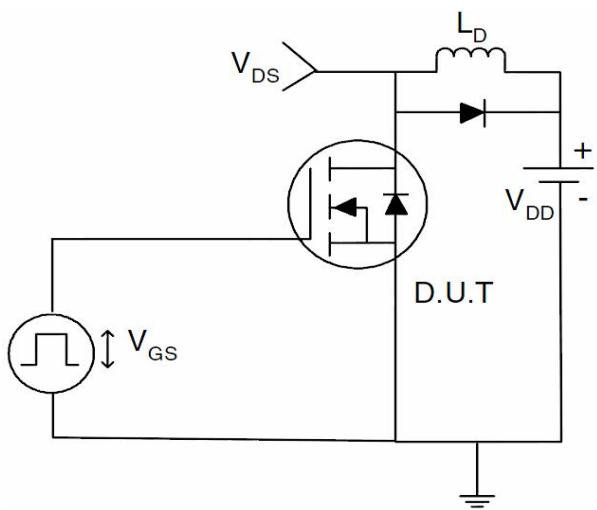
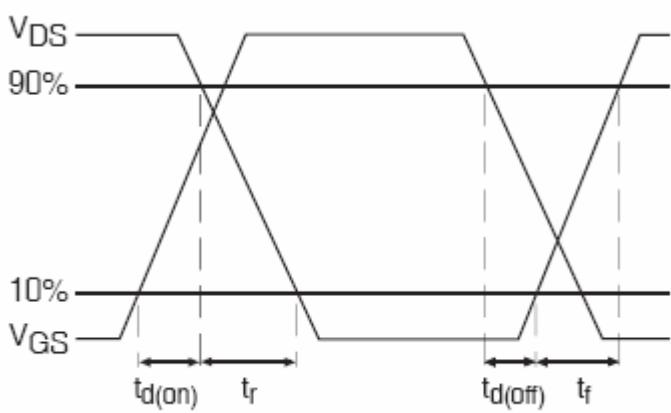
### 1) E<sub>AS</sub> Test Circuits



### 2) Gate Charge Test Circuit:

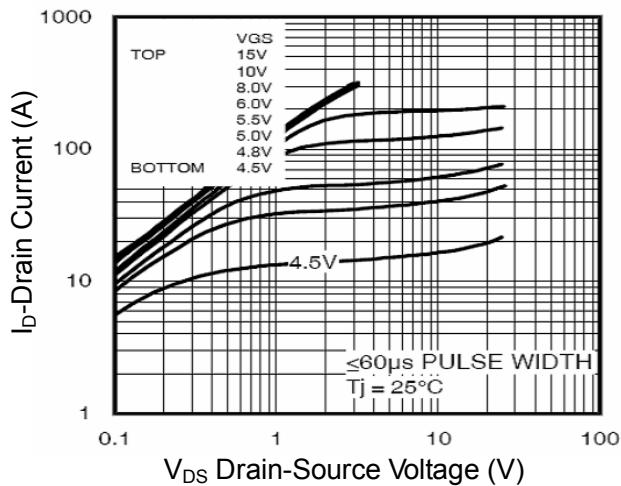


### 3) Switch Time Test Circuit:

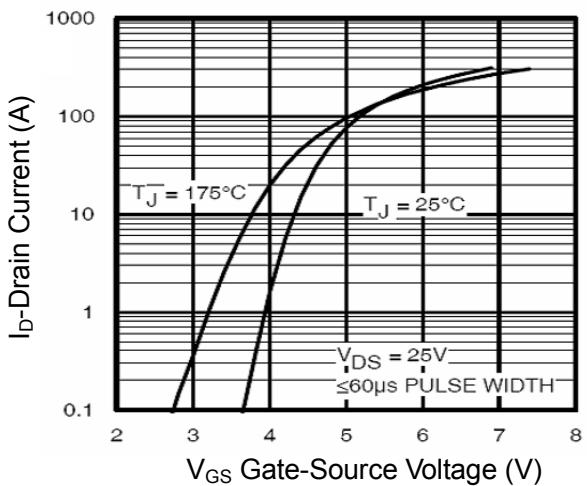


## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

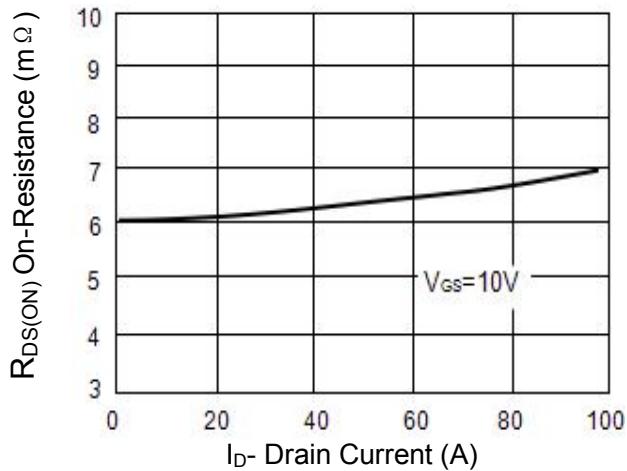
**Figure1. Output Characteristics**



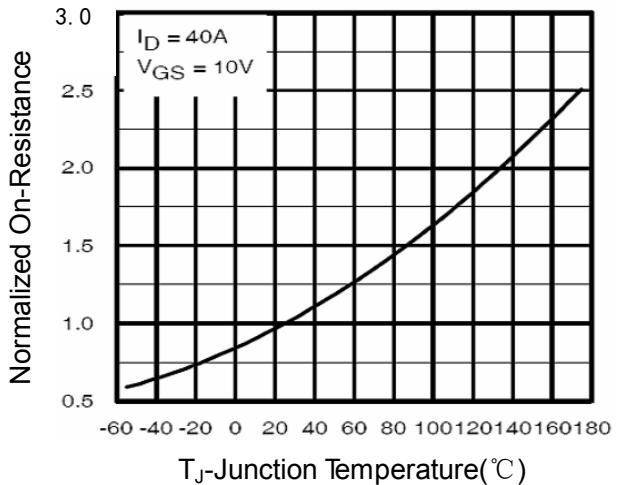
**Figure2. Transfer Characteristics**



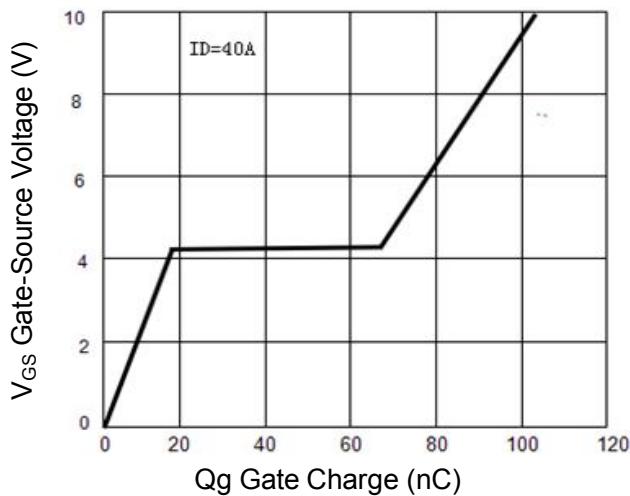
**Figure3. Rdson Vs Drain Current**



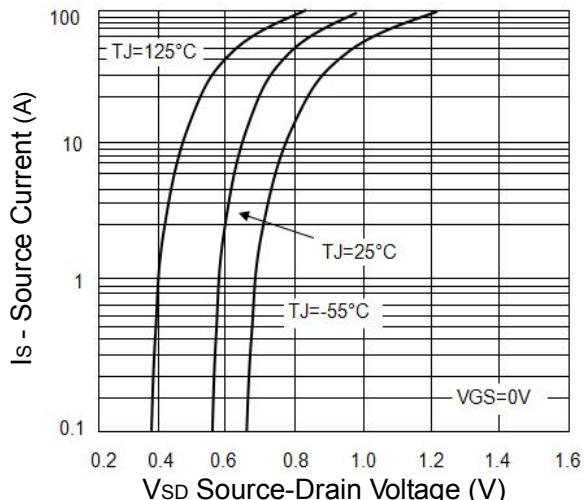
**Figure4. Rdson Vs Junction Temperature**



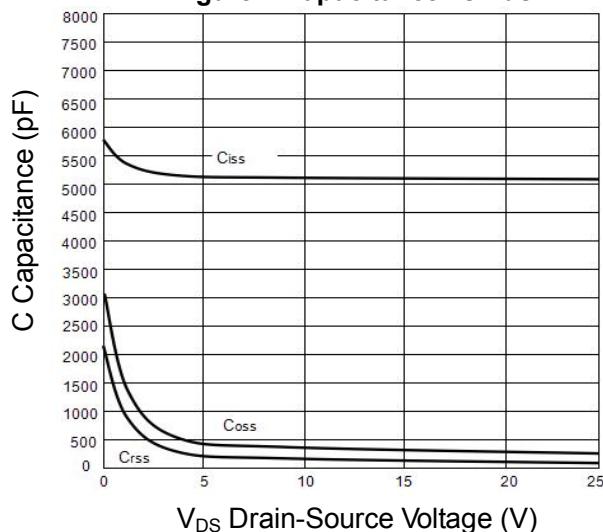
**Figure5. Gate Charge**



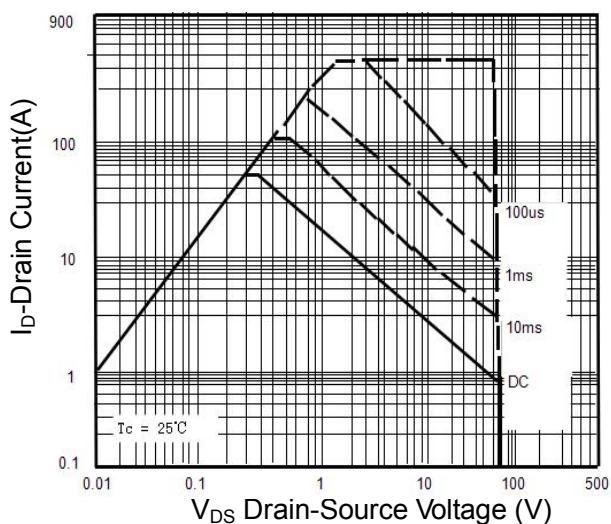
**Figure6. Source- Drain Diode Forward**



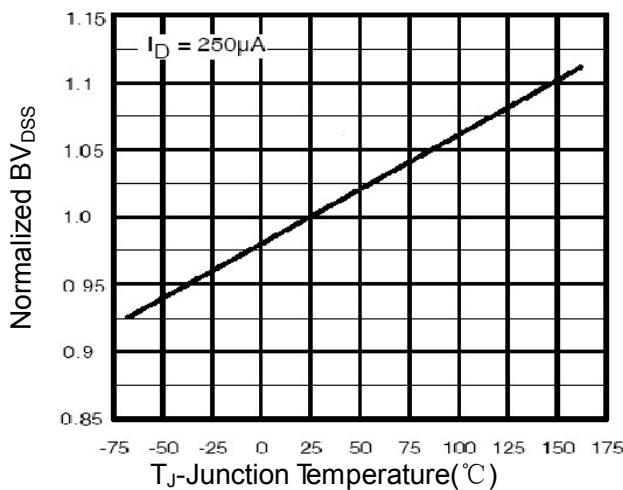
**Figure7. Capacitance vs Vds**



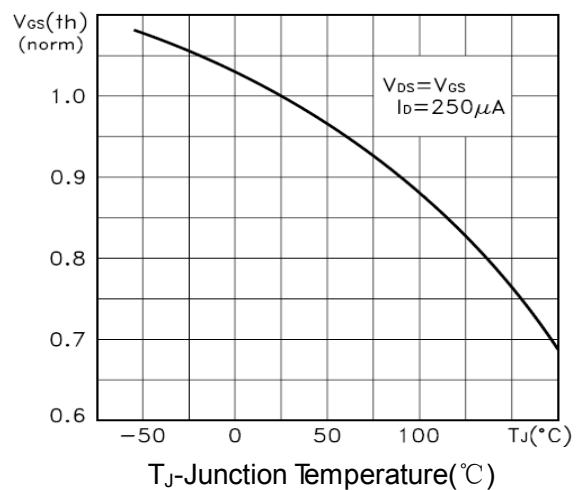
**Figure8. Safe Operation Area**



**Figure9. BVDSS vs Junction Temperature**



**Figure10.  $\text{VGS(th)}$  vs Junction Temperature**



**Figure11. Normalized Maximum Transient Thermal Impedance**

